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General Information

Series	KPS-MCC Indust COG HT200C
Style	Leaded Stacked Chip
Description	Low ESR, Stacked Ceramic Chips
Features	200C, Low ESR, High Thermal Stability, Bulk Capacitance
RoHS	With Exemptions
REACH	SVHC (Pb - CAS 7439-92-1)
SCIP Number	297427bb-2a48-4853-b594-641304a2cc24
Termination	Silver
Lead	L Leads
AEC-Q200	No
Notes	Number of chips in this stack: 6.

Specifications

Capacitance	0.12 uF
Tolerance	10%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2,400 VDC
Temperature Range	-55/+200°C
Temp. Coefficient	COG
Dissipation Factor	0.1% 1 kHz 25C
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	8.33 GOhms

Dimensions

D	25.64mm +/-0.635mm
L	1.4mm +/-0.127mm
H	2.54mm NOM
F	1.778mm +/-0.25mm
A	8.13mm MAX
B	10.162mm MAX
C	11.43mm +/-0.635mm
E	13.7mm +/-0.89mm
K	0.5mm NOM

Packaging Specifications

Packaging	Waffle, Box
Packaging Quantity	16

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